



# PRODUCT DATASHEET

- SMC High Power
- 3030 SMC 2.05t
  Series
- Green (525nm)



Compliant

# 3030 SMC Series



- Package: TOP View SMC Package with Silicon Lens
- Forward Current: 350mA
- Forward Voltage (typ.): 3.2V
- Luminous Flux (typ.): 100lm@350mA

ATTENTION

OBSERVE PRECAUTI FOR HANDLING

- Colour: Green
- Wavelength: 525nm
- Viewing angle: 90°
- Materials:
  - Die: InGaN
  - Resin: Silicon (Water Clear)
  - L/T Finish: Ag plated
- Operating Temperature: -40~+80°C
- Storage Temperature: -40~+100°C
- Grouping parameters:
  - Forward Voltage
  - Luminous Flux
  - Dominant Wavelength
- Soldering methods: IR Reflow
- Preconditioning: MSL2 according to J-STD020
- Packing: 12mm tape with 500pcs Min./reel, ø180mm (7")



Decorative Lighting

N0G25S55

- Portable Lighting
- Outdoor Lighting
- Commercial Lighting
- Architectural Lighting
- Industrial Lighting



# CHARACTERISTICS:

# Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	lf	500	mA
Reverse Voltage	VR	5	V
Reverse Current @5V	Ir	10	μΑ
Junction Temperature	Tj	125	°C
Electrostatic Discharge (HBM: MIL-STD-883 C2)	ESD	2000	V
Operating Temperature	Topr	-40~+80	°C
Storage Temperature	T <sub>stg</sub>	-40~+100	°C
Soldering Temperature	Tsol	260	°C

## Electrical & Optical Characteristics (Ta=25°C)

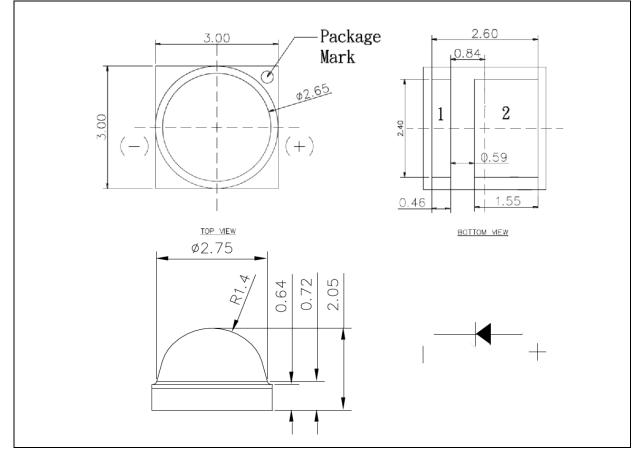
Daramatar Sumbol		Values			Unit	Test
Parameter Symbol	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	$V_{\text{F}}$	2.8		3.6	V	I <sub>F</sub> =350mA
Luminous Flux	Φv	75		120	lm	I⊧=350mA
Dominant Wavelength	$\lambda_{\text{D}}$	520		530	nm	I⊧=350mA
Viewing Angle	20 <sub>1/2</sub>		90		deg	l⊧=350mA

1. Luminous flux ( $\Phi_{V})$  ±7%, Forward Voltage (V\_F) ±0.05V, Viewing angle(2 $\theta_{1/2})$  ±10°



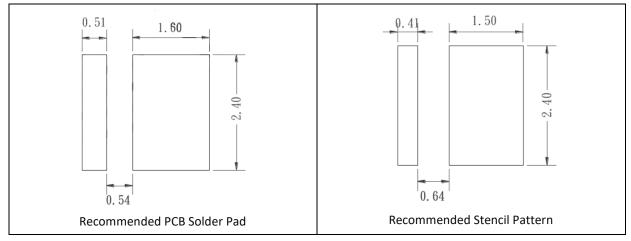
# **OUTLINE DIMENSION:**

#### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

#### Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- **2.** Tolerance  $\pm 0.12$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



# **BINNING GROUPS:**

Code	Min.	Max.	Unit
V2830	2.8	3.0	
V3032	3.0	3.2	M
V3234	3.2	3.4	v
V3436	3.4	3.6	

## Forward Voltage Classifications (I<sub>F</sub> = 350mA):

#### Luminous Flux Classifications (I<sub>F</sub> = 350mA):

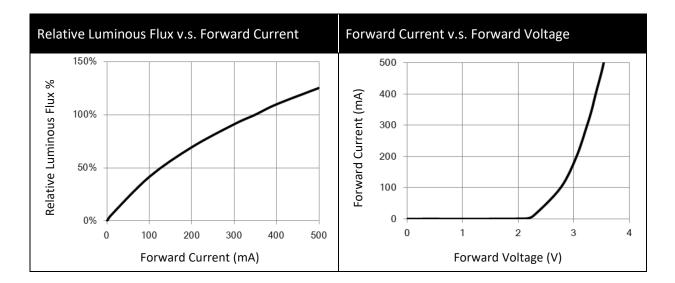
Code	Min.	Max.	Unit
B30	75	80	
B31	80	90	
B32	90	100	lm
B33	100	110	
B34	110	120	

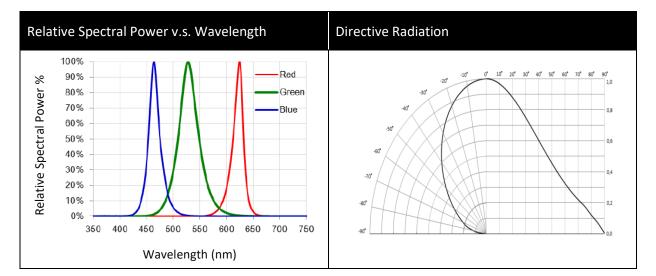
#### Dominant Wavelength Classifications (I<sub>F</sub> = 350mA):

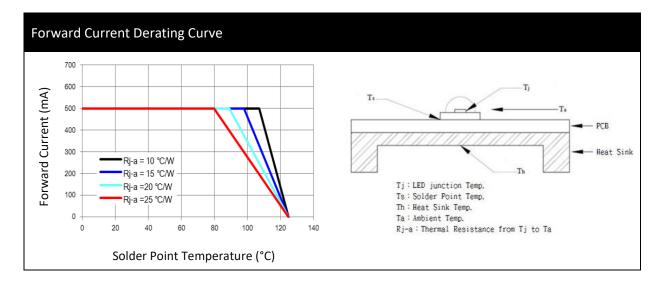
Code	Min.	Max.	Unit	
G520	520	525		
G525	525	530	nm	



# **ELECTRO-OPTICAL CHARACTERISTICS:**



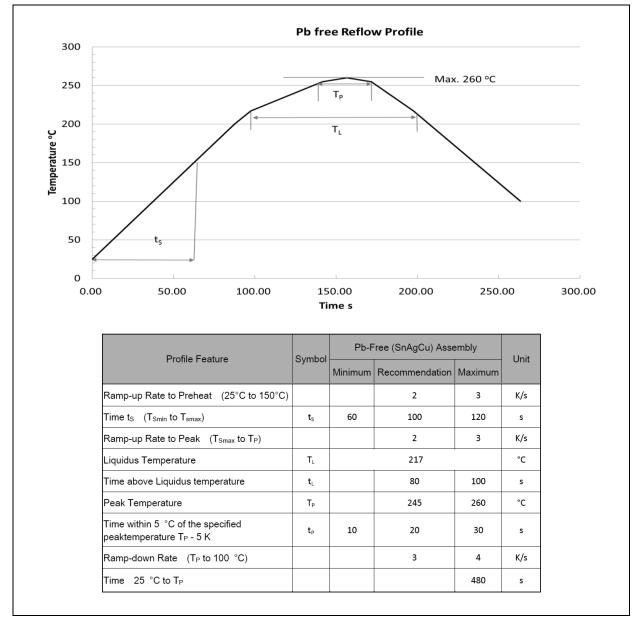






# **RECOMMENDED SOLDERING PROFILE:**

#### IR Reflow Lead-free Solder:



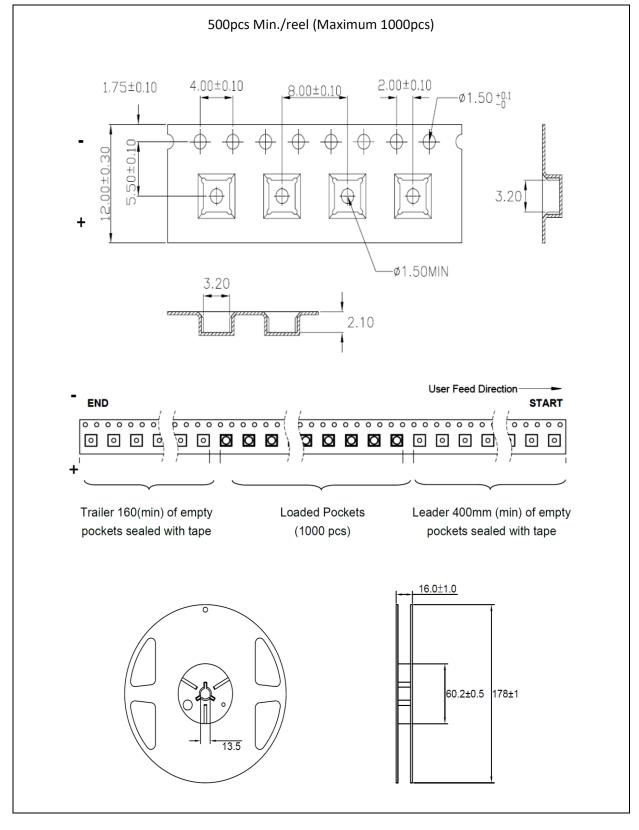
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. The recommended soldering temperature is 245°C. Maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



# **PACKING SPECIFICATION:**

#### Reel Dimension:



# **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

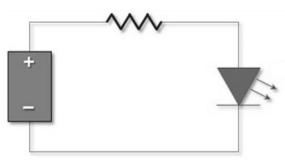
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision	
A1.0	26/05/2016	Datasheet set-up.	
A1.1	06/04/2018	Revise lead frame solder pad design.	